



Final Product Change Notification

201511014F01

Issue Date: 18-Dec-2015

Effective Date: 01-Apr-2016

Dear

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

Management Summary

Transfer of the RC3 line in ASMC from 125mm to 150mm.

Change Category

<input checked="" type="checkbox"/> Wafer Fab process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Electrical spec./Test coverage	<input type="checkbox"/> Mechanical Specification
<input type="checkbox"/> Wafer Fab location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Test Location	<input type="checkbox"/> Packing/Shipping/Labeling

ASMC 5" to 6" RC3 transfer

Details of this Change

This is to notify customers of the transfer of the RC3 process as run at ASMC from the 125mm line to the 150mm line.

It should be noted that no mask or ATE-FT spec changes were made so parts are subject to the same datasheet parameters.

Why do we implement this Change

Consolidate manufacturing capacity within ASMC.

Identification of Affected Products

Product identification does not change

Product can be distinguished by date coding of material.

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 04-Mar-2016

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 17-Jan-2016.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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Changed Orderable Part#

SA636DK/01,118
SA636BS,115
SA614AD/01,118
SA615D/01,118
SA615DK/01,118
SA636DK/01,112
SA606DK/01,112
SA602AD/01,118
SA616DK/01,118
SA612AD/01,112
SA606DK/01,118
SA616DK/01,112
SA639DH/01,118
SA604AD/01,112
SA614AD/01,112
SA616BS,115
SA602AD/01,112
SA605DK/01,112
SA605D/01,112